## CALL FOR PAPERS

17th US-Japan Conference on Composite Materials: August 1(Mon) & 2(Tue), 2016, Hokkaido University, Sapporo, Japan

The Japan Society for Composite Materials (JSCM) and the American Society for Composites (ASC) invite you to submit an abstract for the 17th US-Japan Conference on Composite Materials. The conference will feature technical sessions, panel discussions, keynote addresses and international sessions highlighting advances in the analysis, design, manufacturing, and applications of advanced composites.

## **Conference Themes**

Joining and Adhesive Bonding, Advanced Analysis Methods, Out-of-Autoclave Composites, Fibers, Textiles & Preforms, Fatigue, Fracture & Residual Strength, Damage Growth Prediction, Environmental and Recycling, Nano-composites, Maintenance, Inspection & Repair, Wind Energy & Renewable Energy, Offshore and Marine Applications, Automotive & Ground Transportation, Infrastructure & Architectural Application, Composites, Test methods & Certification, Structural Health Monitoring & NDE, Durability, Multi-scale modeling and mechanics, Bio-composites, Composites in Education, Other related composites themes

## **ABSTRACT & MANUSCRIPT SUBMISSION**

Individuals or organizations interested in presenting should submit a 1 page summary (title, authors, e-mail address of all authors and abstract of 100-500 words) for review.

February 26, 2016: Abstract Submission Deadline

March 18, 2016: Notice of Acceptance May 27, 2016: Final Paper Submission

June 10, 2016: Early Registration Deadline

For manuscript submission, early registration or more information, visit the website at <a href="http://labs.eng.hokudai.ac.jp/labo/intelligent\_design/english/">http://labs.eng.hokudai.ac.jp/labo/intelligent\_design/english/</a>

For administrative assistance and questions contact:

Conference Chair (Japan): Yoshihiro Narita, <a href="mailto:ynarita@eng.hokudai.ac.jp">ynarita@eng.hokudai.ac.jp</a> and

Conference Secretariat: Shinya Honda, honda@eng.hokudai.ac.jp

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Conference Chair (US): Prof. H. Kim, UC San Diego, hyonny@ucsd.edu